



CALL FOR PAPERS

ICSPI 2021
Feb 04-05, 2021
Bangkok, Thailand

The International Research Conference is a federated organization dedicated to bringing together a significant number of diverse scholarly events for presentation within the conference program. Events will run over a span of time during the conference depending on the number and length of the presentations.

ICSPI 2021 : International Conference on Signal and Power Integrity is the premier interdisciplinary forum for the presentation of new advances and research results in the fields of Signal and Power Integrity. The conference will bring together leading academic scientists, researchers and scholars in the domain of interest from around the world. Topics of interest for submission include, but are not limited to:

Innovative schemes for SI and PI

Noise reduction techniques

High-speed link design and modeling

Power distribution networks

Electronic packages and microsystems

3D technologies for IC and packages

RF, microwave mixed signal packaging

Nano-interconnects and nano structures

Electromagnetic theory and modeling

Transmission line theory and modeling

Macro-modeling, reduced order models

Simulation tools for SI and PI

Electromagnetic Compatibility

Design methodology/flow

Time and frequency-domain measurements

Jitter and noise modeling

Chip-package co-design

Novel CAD concepts